

TJ11A10M3

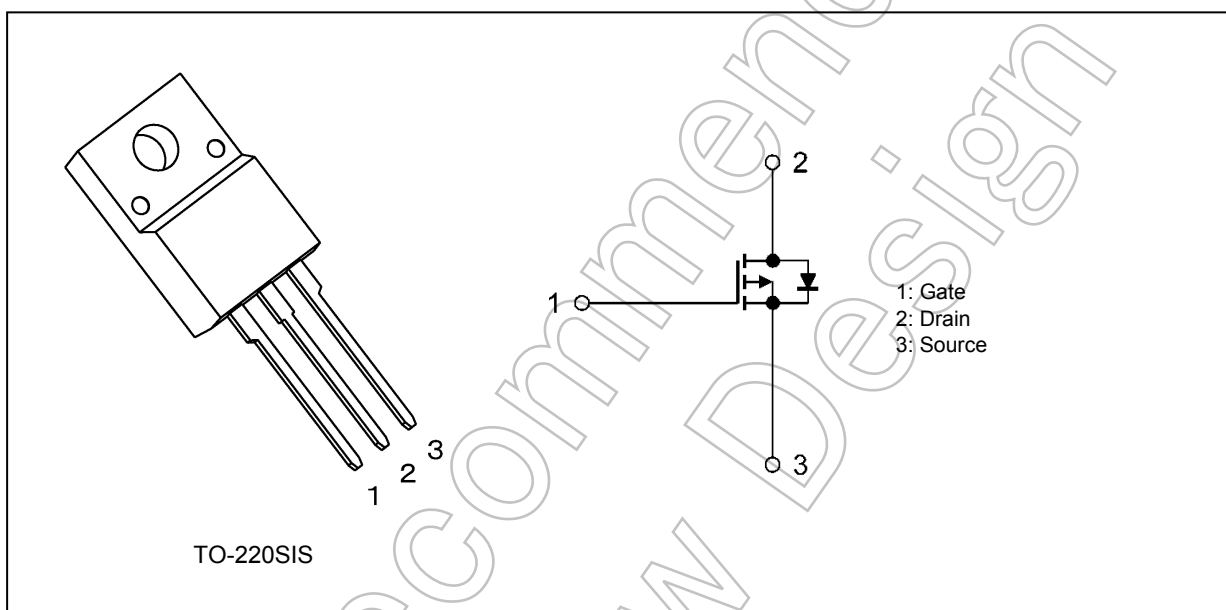
1. Applications

- Switching Voltage Regulators

2. Features

- Low drain-source on-resistance: $R_{DS(ON)} = 100 \text{ m}\Omega$ (typ.) ($V_{GS} = -10 \text{ V}$)
- Low leakage current: $I_{DSS} = -10 \text{ }\mu\text{A}$ (max) ($V_{DS} = -100 \text{ V}$)
- Enhancement mode: $V_{th} = -2.0$ to -4.0 V ($V_{DS} = -10 \text{ V}$, $I_D = -1 \text{ mA}$)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) ($T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	V_{DSS}	-100	V
Gate-source voltage	V_{GSS}	± 20	
Drain current (DC) (Note 1)	I_D	-11	A
Drain current (pulsed) (Note 1)	I_{DP}	-22	
Power dissipation ($T_c = 25^\circ\text{C}$)	P_D	24	W
Single-pulse avalanche energy (Note 2)	E_{AS}	37	mJ
Avalanche current	I_{AR}	-11	A
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Start of commercial production

2010-08

5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	$R_{th(ch-c)}$	5.2	°C/W
Channel-to-ambient thermal resistance	$R_{th(ch-a)}$	62.5	

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = -25\text{ V}$, $T_{ch} = 25^\circ\text{C}$ (initial), $L = 500\text{ }\mu\text{H}$, $R_G = 25\text{ }\Omega$, $I_{AR} = -11\text{ A}$

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

Not Recommended
for New Design

6. Electrical Characteristics

6.1. Static Characteristics ($T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	I_{GSS}	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	—	—	± 0.1	μA
Drain cut-off current	I_{DSS}	$V_{DS} = -100\text{ V}, V_{GS} = 0\text{ V}$	—	—	-10	
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = -10\text{ mA}, V_{GS} = 0\text{ V}$	-100	—	—	V
Drain-source breakdown voltage (Note 3)	$V_{(BR)DSX}$	$I_D = -10\text{ mA}, V_{GS} = 20\text{ V}$	-75	—	—	
Gate threshold voltage	V_{th}	$V_{DS} = -10\text{ V}, I_D = -1\text{ mA}$	-2.0	—	-4.0	
Drain-source on-resistance	$R_{DS(ON)}$	$V_{GS} = -10\text{ V}, I_D = -5.5\text{ A}$	—	100	130	$\text{m}\Omega$
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = -10\text{ V}, I_D = -5.5\text{ A}$	15	30	—	S

Note 3: If a reverse bias is applied between gate and source, this device enters $V_{(BR)DSX}$ mode. Note that the drain-source breakdown voltage is lowered in this mode.

6.2. Dynamic Characteristics ($T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	C_{iss}	$V_{DS} = -10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	3200	—	pF
Reverse transfer capacitance	C_{rss}		—	135	—	
Output capacitance	C_{oss}		—	190	—	
Switching time (rise time)	t_r	See Figure 6.2.1.	—	12	—	ns
Switching time (turn-on time)	t_{on}		—	28	—	
Switching time (fall time)	t_f		—	41	—	
Switching time (turn-off time)	t_{off}		—	290	—	

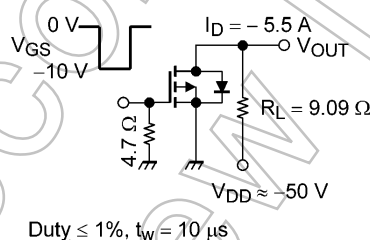


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Q_g	$V_{DD} \approx -80\text{ V}, V_{GS} = -10\text{ V}, I_D = -11\text{ A}$	—	69	—	nC
Gate-source charge 1	Q_{gs1}		—	9.4	—	
Gate-drain charge	Q_{gd}		—	20	—	

6.4. Source-Drain Characteristics ($T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Reverse drain current (DC) (Note 4)	I_{DR}	—	—	—	-11	A
Reverse drain current (pulsed) (Note 4)	I_{DRP}		—	—	-22	
Diode forward voltage	V_{DSF}	$I_{DR} = -11\text{ A}, V_{GS} = 0\text{ V}$	—	—	1.4	V
Reverse recovery time	t_{rr}	$I_{DR} = -11\text{ A}, V_{GS} = 0\text{ V}$ $dI_{DR}/dt = 50\text{ A}/\mu\text{s}$	—	70	—	ns
Reverse recovery charge	Q_{rr}		—	95	—	nC

Note 4: Ensure that the channel temperature does not exceed 150°C .

7. Marking (Note)

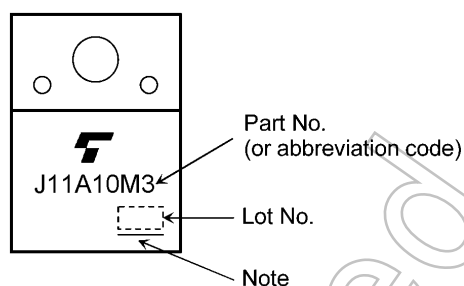


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

8. Characteristics Curves (Note)

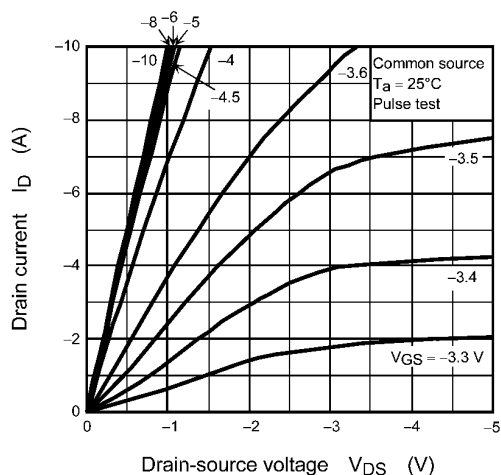


Fig. 8.1 $I_D - V_{DS}$

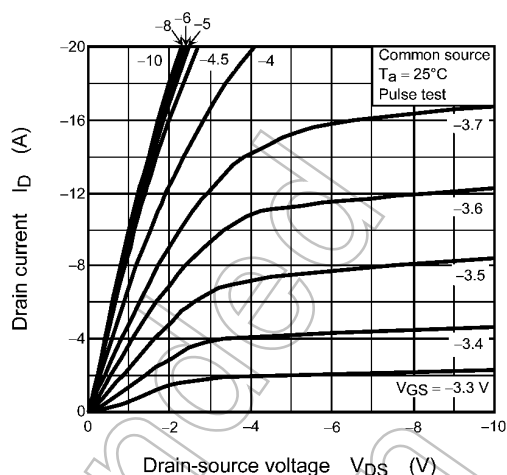


Fig. 8.2 $I_D - V_{DS}$

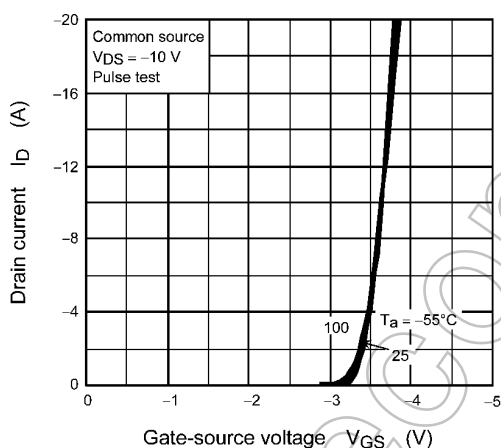


Fig. 8.3 $I_D - V_{GS}$

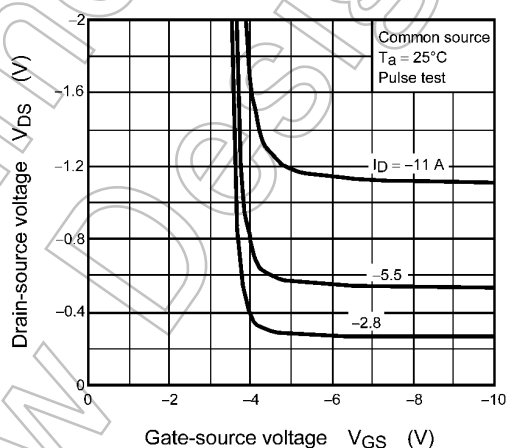


Fig. 8.4 $V_{DS} - V_{GS}$

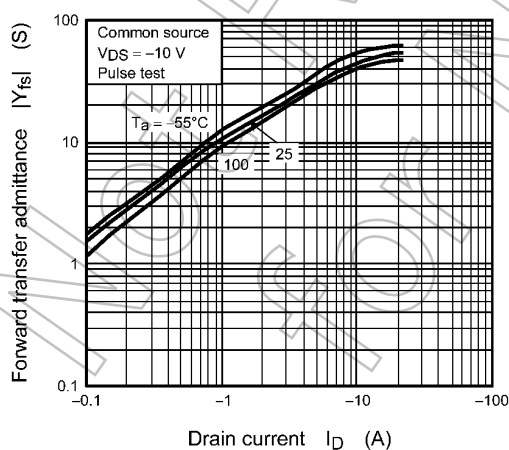


Fig. 8.5 $|Y_{fs}| - I_D$

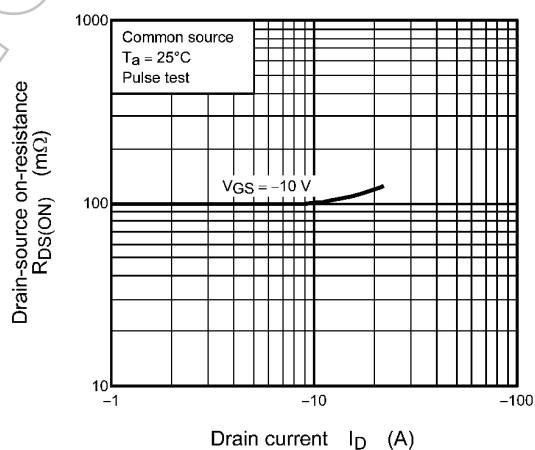


Fig. 8.6 $R_{DS(ON)} - I_D$

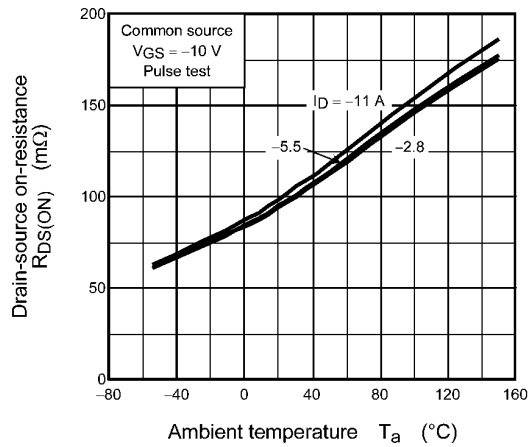


Fig. 8.7 $R_{DS(ON)} - T_a$

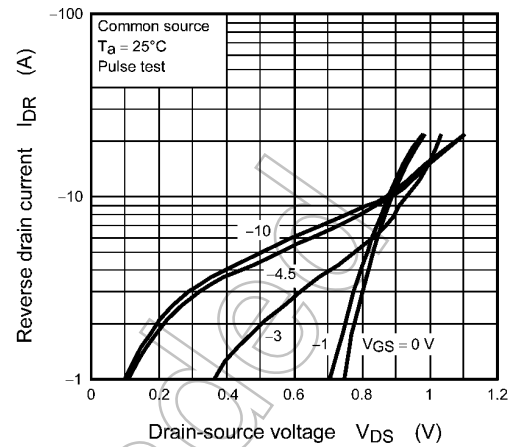


Fig. 8.8 $I_{DR} - V_{DS}$

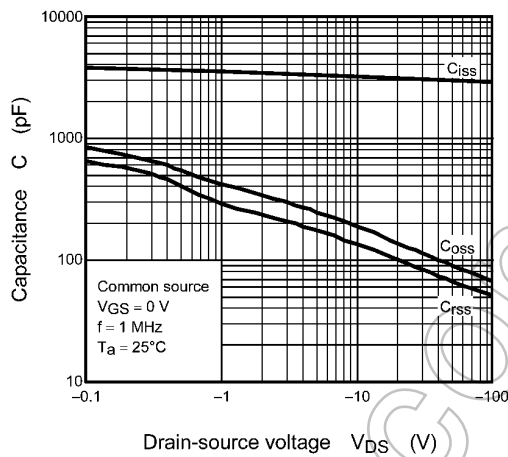


Fig. 8.9 Capacitance - V_{DS}

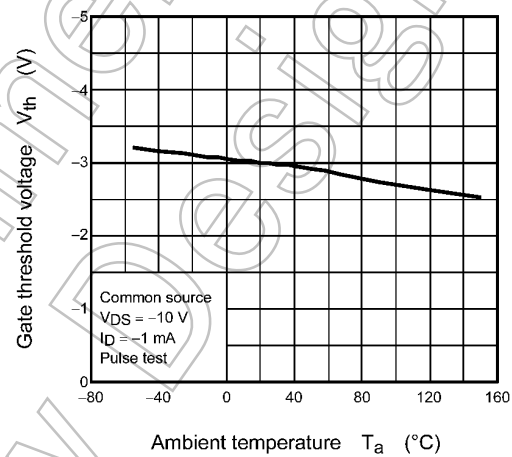


Fig. 8.10 $V_{th} - T_a$

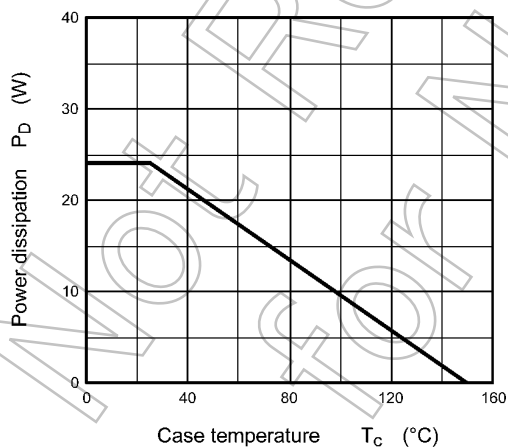


Fig. 8.11 $P_D - T_c$
(Guaranteed Maximum)

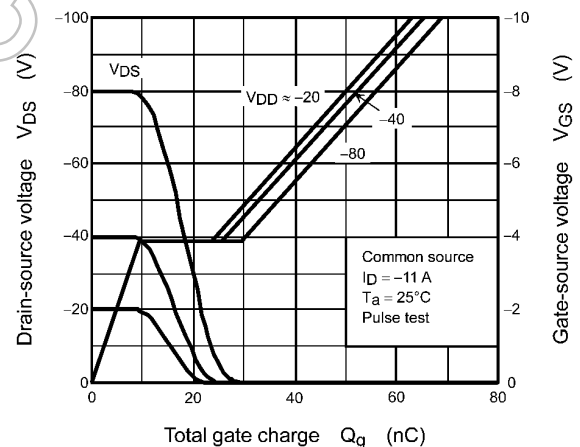


Fig. 8.12 Dynamic Input/Output Characteristics

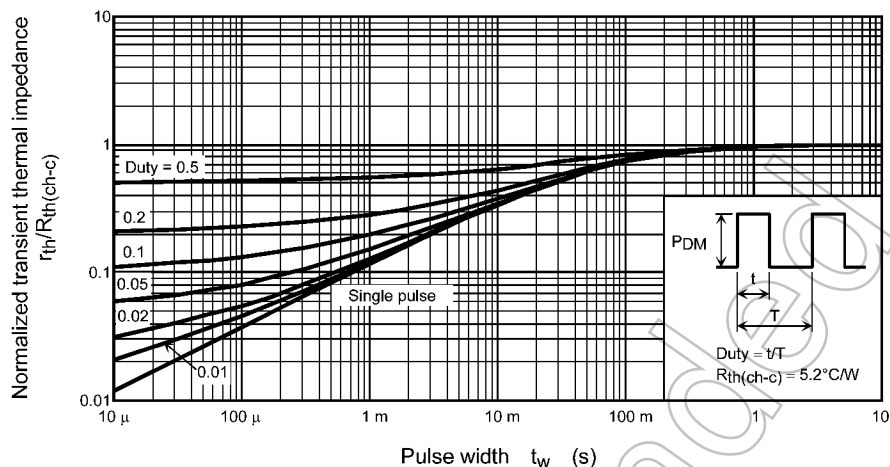


Fig. 8.13 $r_{th}/R_{th(ch-c)} - t_w$
(Guaranteed Maximum)

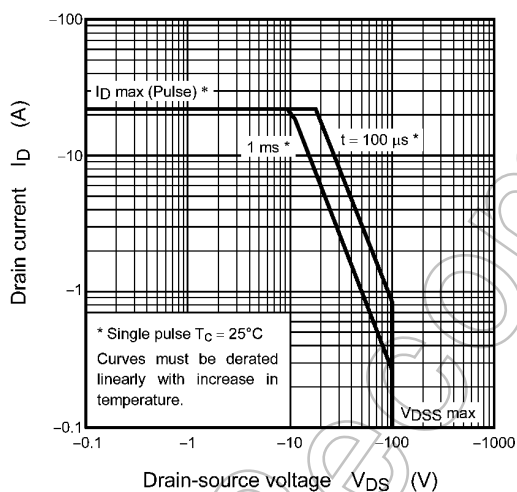


Fig. 8.14 Safe Operating Area
(Guaranteed Maximum)

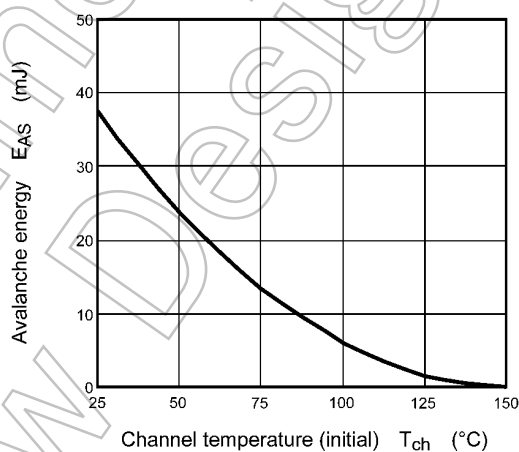
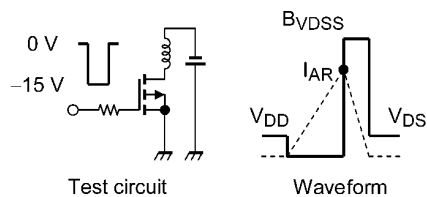


Fig. 8.15 $E_{AS} - T_{ch}$
(Guaranteed Maximum)



$$R_G = 25 \, \Omega$$

$$V_{DD} = -25 \, \text{V}, I_{AR} = -11 \, \text{A}$$

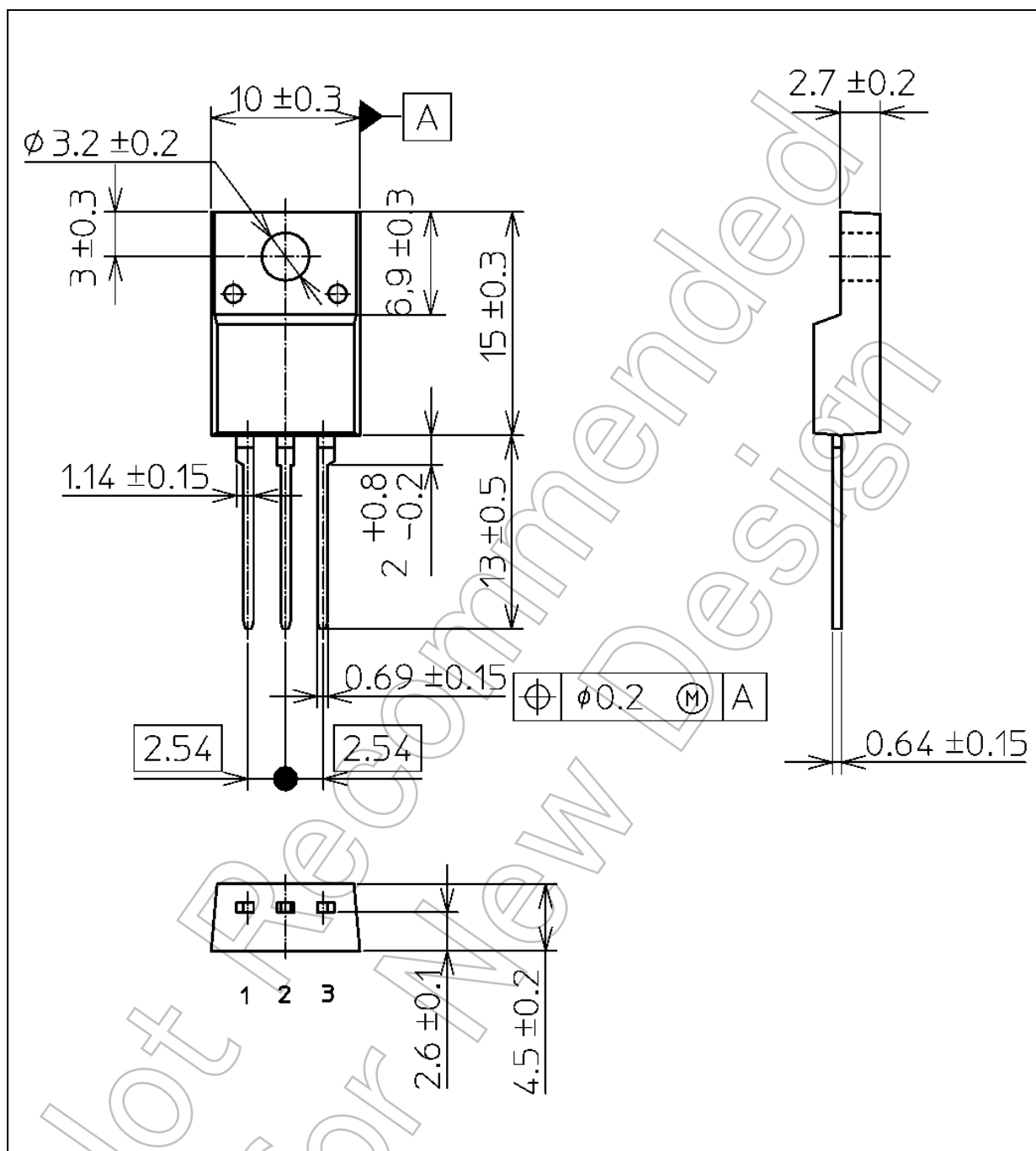
$$E_{AS} = \frac{1}{2} \cdot L \cdot I_{AR}^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

Fig. 8.16 Test Circuit/Waveform

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 1.7 g (typ.)

Package Name(s)
TOSHIBA: 2-10U1S
Nickname: TO-220SIS

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